ASOCIATION CONNECTING ELECTRONICS INDUSTRIES® INTERNATIONAL OF THE STATE	mockburn, Illinois. A	ll rights reserved utions.	under both	This docume level parts, t	ent is a declarat he declaration e	ion of the su encompasse	ubstances s all lowe	within the manufa r level materials fo	cturer listed or which the	l item. Note manufactu	: if the item is an a rer has engineering	ssembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute			k	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials a					and Mfg Information			
Supplier Information													
Company name*	que ID	e ID U			Unique ID Authority				Response Date*				
onsemi										2025-06-04			
Contact Name	Title - Contact]	Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards	v-Stewards Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com				
athorized Representative* Title - Representative				Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards Product Enviro Co			o Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number M:	fr Item Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
LN	M2931ACD2TR4G	BIACD2TR4G ANA 0.1A ADJ OU			2025-06-04		N	MY1		1617.91	mg	Each	
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Base A	Terminal Base Alloy J-		Rating	Peak Process Bod		Body Temperature Max Time at Peak		eak Temper	Temperature Number of Reflow Cycles		cles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	sec	onds 3			
Comments													
level 1 - maximum time at peak temperature dur	ing soldering is 10-3	0 seconds											
For more information regarding material compo	sition please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, admium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part incompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, is of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive and that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not ndependently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the ertification in this paragraph. If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of has applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.19	mg	Supplier	Silicon (Si)	7440-21-3		0.19	mg
Die Attach	11.31	mg	А	Lead (Pb)	7439-92-1	7a	10.7445	mg
			Supplier	Tin (Sn)	7440-31-5		0.5655	mg
Lead Frame	851.27	mg	В	Nickel (Ni)	7440-02-0		2.5538	mg
			Supplier	Copper (Cu)	7440-50-8		848.7162	mg
Mold Compound-Black	727.25	mg		Epoxy resin	proprietary data		50.9075	mg
			Supplier	Phenolic Resin	Proprietary Data		21.8175	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		72.725	mg
			Supplier	Carbon Black (C)	1333-86-4		3.6363	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		578.1638	mg
Plating	27.15	mg	Supplier	Tin (Sn)	7440-31-5		27.15	mg
Wire Bond - Cu	0.74	mg	Supplier	Copper (Cu)	7440-50-8		0.74	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signar range of distribution unless otherwise noted)